

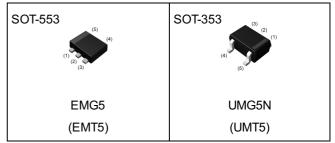
# Emitter common (dual digital transistor)

| Parameter            | DTr1 and DTr2 |
|----------------------|---------------|
| V <sub>CC</sub>      | 50V           |
| I <sub>C(MAX.)</sub> | 100mA         |
| R <sub>1</sub>       | 10kΩ          |
| R <sub>2</sub>       | 47kΩ          |

#### Features

- 1)Two DTC114Y chips in a EMT or UMT package
- 2) Mounting cost and area can be cut in half.

#### Outline



#### •Inner circuit

(1) DTr1 IN(Base) (5) (4
(2) DTr1 / DTr2
GND(Emitter) (3) DTr2 IN(Base) (4) DTr2 OUT(Collector) (5) DTr1 OUT(Collector)

(1)

(2)

# Application

INVERTER, INTERFACE, DRIVER

# Packaging specifications

| Part No. | Package           | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width<br>(mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
|----------|-------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| EMG5     | SOT-553<br>(EMT5) | 1616            | T2R            | 180               | 8                  | 8000                            | G5      |
| UMG5N    | SOT-353<br>(UMT5) | 2021            | TR             | 180               | 8                  | 3000                            | G5      |

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# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

| Parameter                    |       | Symbol                 | Values      | Unit        |
|------------------------------|-------|------------------------|-------------|-------------|
| Supply voltage               |       | V <sub>CC</sub>        | 50          | V           |
| Input voltage                |       | V <sub>IN</sub>        | -6 to 40    | V           |
| Output current               |       | Io                     | 70          | mA          |
| Collector current            |       | I <sub>C(MAX)</sub> *1 | 100         | mA          |
| Davis a dia sin atia a       | EMG5  | P <sub>D</sub> *2*3    | 150         | \^//To.to.l |
| Power dissipation            | UMG5N | P <sub>D</sub> *2*3    | 150         | ──mW/Total  |
| Junction temperature         |       | T <sub>j</sub>         | 150         | °C          |
| Range of storage temperature |       | T <sub>stg</sub>       | -55 to +150 | °C          |

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

| Davamatar            | Cymahal                        | Conditions  | Values |      |      | l leit     |  |
|----------------------|--------------------------------|---|--------|------|------|------------|--|
| Parameter            | Symbol                         | Conditions  | Min.   | Тур. | Max. | Unit       |  |
| lanut valtaga        | $V_{l(off)}$                   | $V_{CC} = 5V, I_{O} = 100 \mu A$                            | -      | -    | 0.3  | \ <u>'</u> |  |
| Input voltage        | V <sub>I(on)</sub>             | V <sub>O</sub> = 0.3V, I <sub>O</sub> = 1mA                 | 1.4    | -    | -    | V          |  |
| Output voltage       | V <sub>O(on)</sub>             | I <sub>O</sub> = 5mA, I <sub>I</sub> = 0.25mA               | -      | 100  | 300  | mV         |  |
| Input current        | I <sub>I</sub>                 | V <sub>I</sub> = 5V   | -      | -    | 880  | μA         |  |
| Output current       | I <sub>O(off)</sub>            | V <sub>CC</sub> = 50V, V <sub>I</sub> = 0V                  | -      | -    | 500  | nA         |  |
| DC current gain      | G <sub>I</sub>                 | $V_{O} = 5V, I_{O} = 5mA$                                   | 68     | -    | -    | -          |  |
| Input resistance     | R <sub>1</sub>                 | -   | 7      | 10   | 13   | kΩ         |  |
| Resistance ratio     | R <sub>2</sub> /R <sub>1</sub> | -   | 3.7    | 4.7  | 5.7  | •          |  |
| Transition frequency | f <sub>T</sub> *1              | V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA,<br>f = 100MHz | -      | 250  | 1    | MHz        |  |

<sup>\*1</sup> Characteristics of built-in transistor.

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3 120</sup>mW per element must not be exceeded.

# ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

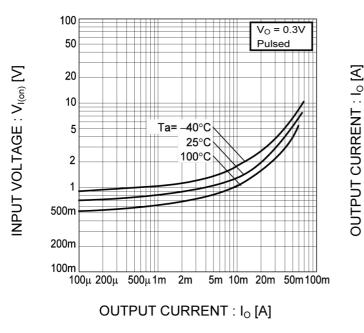


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

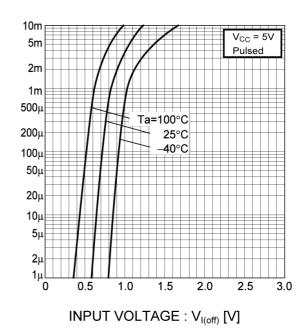


Fig.3 Output Current vs. Output Voltage

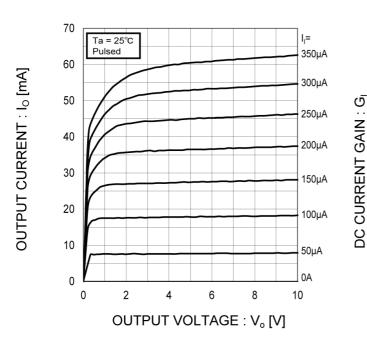
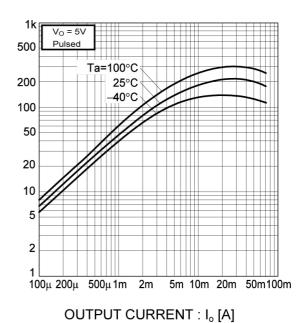


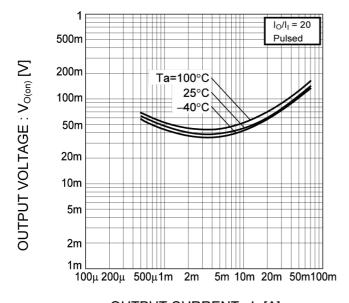
Fig.4 DC Current Gain vs. Output Current



# ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

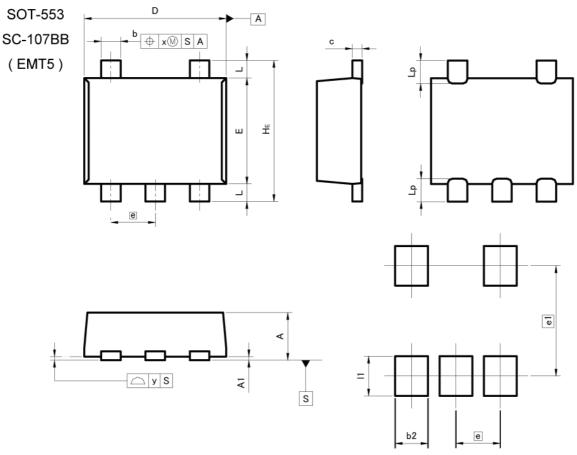
<For DTr1 and DTr2 in common>

Fig.5 Output Voltage vs. Output Current



OUTPUT CURRENT : Io [A]

# Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

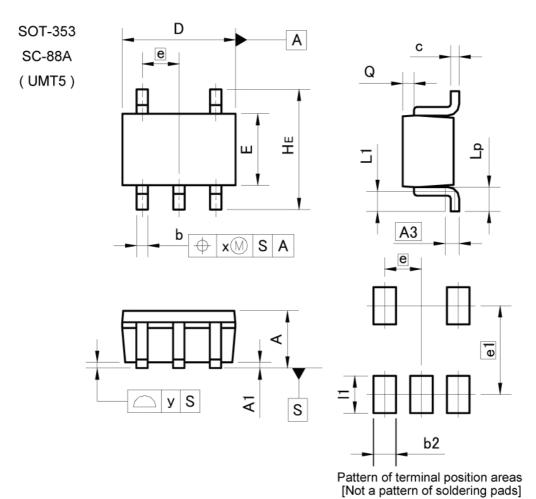
| DIM | MILIMETERS |      | INCHES |       |
|-----|------------|------|--------|-------|
| DIM | MIN        | MAX  | MIN    | MAX   |
| Α   | 0.45       | 0.55 | 0.018  | 0.022 |
| A1  | 0.00       | 0.10 | 0.000  | 0.004 |
| b   | 0.17       | 0.27 | 0.007  | 0.011 |
| С   | 0.08       | 0.18 | 0.003  | 0.007 |
| D   | 1.50       | 1.70 | 0.059  | 0.067 |
| E   | 1.10       | 1.30 | 0.043  | 0.051 |
| е   | 0.         | 50   | 0.020  |       |
| HE  | 1.50       | 1.70 | 0.059  | 0.067 |
| L   | 0.10       | 0.30 | 0.004  | 0.012 |
| Lp  | _          | 0.35 | -      | 0.014 |
| х   | _          | 0.10 | _      | 0.004 |
| У   | _          | 0.10 | _      | 0.004 |

| DIM | MILIMETERS |      | INCHES |       |  |
|-----|------------|------|--------|-------|--|
| DIM | MIN        | MAX  | MIN    | MAX   |  |
| b2  | -          | 0.37 | -      | 0.015 |  |
| e1  | 1.25       |      | 0.0    | 49    |  |
| 11  | _          | 0.45 | -      | 0.018 |  |

Dimension in mm/inches



# Dimensions



| DIM | MILIMETERS |      | INC            | HES   |
|-----|------------|------|----------------|-------|
| DIM | MIN        | MAX  | MIN            | MAX   |
| Α   | 0.80       | 1.00 | 0.031          | 0.039 |
| A1  | 0.00       | 0.10 | 0.000          | 0.004 |
| A3  | 0.5        | 25   | 0.0            | 10    |
| b   | 0.15       | 0.30 | 0.006          | 0.012 |
| С   | 0.10       | 0.20 | 0.004          | 0.008 |
| D   | 1.90       | 2.10 | 0.075          | 0.083 |
| E   | 1.15       | 1.35 | 0.045          | 0.053 |
| е   | 0.0        | 65   | 0.026          |       |
| HE  | 2.00       | 2.20 | 0.079          | 0.087 |
| L1  | 0.20       | 0.50 | 0.008          | 0.020 |
| Lp  | 0.25       | 0.55 | 0.010          | 0.022 |
| Q   | 0.10       | 0.30 | 0.004          | 0.012 |
| х   | -          | 0.10 | , <del>-</del> | 0.004 |
| У   |            | 0.10 | e <del></del>  | 0.004 |

| DIM | MILIMETERS |      | INCHES |       |  |
|-----|------------|------|--------|-------|--|
|     | MIN        | MAX  | MIN    | MAX   |  |
| b2  | - 1        | 0.40 | , —    | 0.016 |  |
| e1  | 1.55       |      | 0.0    | 61    |  |
| 11  | -          | 0.65 | -      | 0.026 |  |

Dimension in mm/inches



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|---------|----------|------------|-----------|
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| CLASSIV | CLASSIII | CLASSⅢ     | CLASSIII  |

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